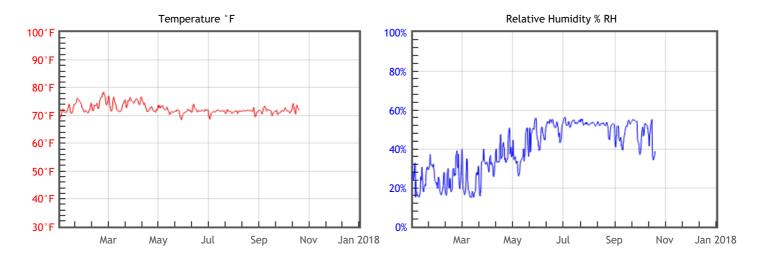
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### **Preservation Environment Evaluation**

Type of Decay	Risks & Metrics	Evaluation & General Comments
Natural Aging Chemical decay of organic materials	OK TWPI = <b>45</b>	Generally OK, but fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics will be at elevated risk due to the cumulative effects of temperature and humidity
Mechanical Damage Physical damage to hygroscopic materials	RISK  % DC = 1.42 % EMC min = 4.8 % EMC max = 9.9	Heightened risk of physical damage to any hygroscopic material, such as paintings, rare books, furniture, paper, leather, film, or color photos, due to extremely low or high levels of humidity, and / or excessive humidity fluctuation.
Mold Risk  Mold growth in area or on collection objects	GOOD  MRF = 0	Minimal risk of mold growth.
Metal Corrosion Corrosion of metal components or objects	OK % EMC max = 9.9	Generally OK, but archeological or salt-encrusted metals may corrode due to extended periods of moderately high levels of humidity.

# **Graphs**



## **Statistics**

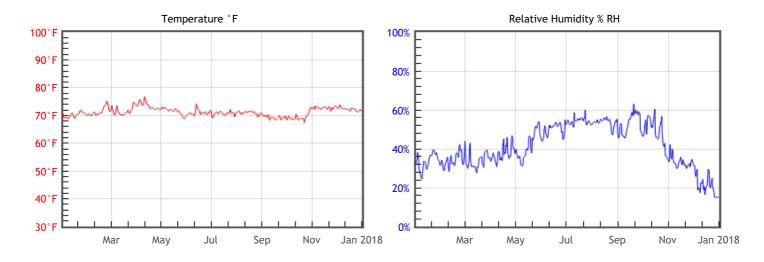
Temperature		Relative Humidity		Dew Point	
T°F Mean	72.6	%RH Mean	36	DP°F Mean	42.4
T°F Median	71.9	%RH Median	35	DP°F Median	44.4
T°F Stdev	1.9	%RH Stdev	14	DP°F Stdev	10.7
T°F Min	68.4	%RH Min	15	DP°F Min	20.4
T°F Max	79.2	%RH Max	71	DP°F Max	63.4

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### **Preservation Environment Evaluation**

Type of Decay	Risks & Metrics	Evaluation & General Comments
Natural Aging Chemical decay of organic materials	OK TWPI = 45	Generally OK, but fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics will be at elevated risk due to the cumulative effects of temperature and humidity
Mechanical Damage Physical damage to hygroscopic materials	RISK  % DC = 1.57  % EMC min = 4.5  % EMC max = 10.1	Heightened risk of physical damage to any hygroscopic material, such as paintings, rare books, furniture, paper, leather, film, or color photos, due to extremely low or high levels of humidity, and / or excessive humidity fluctuation.
Mold Risk  Mold growth in area or on collection objects	GOOD  MRF = 0	Minimal risk of mold growth.
Metal Corrosion Corrosion of metal components or objects	OK % EMC max = 10.1	Generally OK, but archeological or salt-encrusted metals may corrode due to extended periods of moderately high levels of humidity.

# **Graphs**



## **Statistics**

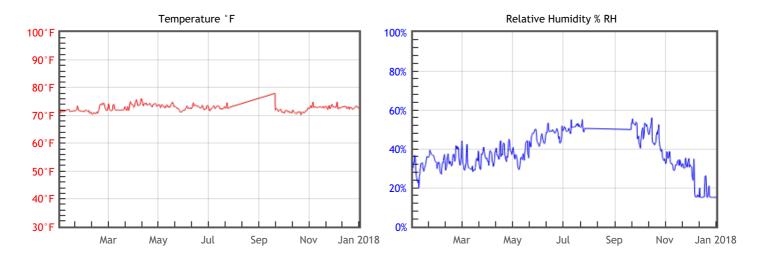
Temperature		Relative Humidity		Dew Point	
T°F Mean	71.3	%RH Mean	39	DP°F Mean	43.7
T°F Median	71.4	%RH Median	36	DP°F Median	43.6
T°F Stdev	1.6	%RH Stdev	11	DP°F Stdev	7.6
T°F Min	67	%RH Min	15	DP°F Min	21.1
T°F Max	76.8	%RH Max	73	DP°F Max	61.9

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### **Preservation Environment Evaluation**

Type of Decay	Risks & Metrics	Evaluation & General Comments
Natural Aging Chemical decay of organic materials	OK TWPI = <b>45</b>	Generally OK, but fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics will be at elevated risk due to the cumulative effects of temperature and humidity
Mechanical Damage Physical damage to hygroscopic materials	RISK  % DC = 1.72  % EMC min = 3.9  % EMC max = 10	Heightened risk of physical damage to any hygroscopic material, such as paintings, rare books, furniture, paper, leather, film, or color photos, due to extremely low or high levels of humidity, and / or excessive humidity fluctuation.
Mold Risk  Mold growth in area or on collection objects	GOOD  MRF = 0	Minimal risk of mold growth.
Metal Corrosion Corrosion of metal components or objects	OK % EMC max = 10	Generally OK, but archeological or salt-encrusted metals may corrode due to extended periods of moderately high levels of humidity.

# **Graphs**



## **Statistics**

Temperature		Relative Humidity		Dew Point	
T°F Mean	72.5	%RH Mean	35	DP°F Mean	42.4
T°F Median	72.8	%RH Median	34	DP°F Median	42.9
T°F Stdev	1.2	%RH Stdev	10	DP°F Stdev	8.4
T°F Min	69.5	%RH Min	15	DP°F Min	21.9
T°F Max	78	%RH Max	68	DP°F Max	62